



Click [here](#) for the 3D model.

Dimensions

Chip Size	2220
L	5.69mm +1.05/-0.41mm (0.224 in +0.041/-0.016 in)
W	5mm +0.79/-0.41mm (0.197 in +0.031/-0.016 in)
T	2.79mm MAX (0.11 in MAX)
B	0.64mm +/-0.46mm (0.025 in +/-0.018 in)

Packaging Specifications

Packaging	Waffle
Packaging Quantity	20

General Information

Series	SMD MIL BP PRF32535
Style	SMD Chip
Description	SMD, Low ESR, MIL-PRF-32535
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov
Termination	Solder Dipped
Failure Rate	N/A
Qualifications	MIL-PRF-32535 M-Level
AEC-Q200	No
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.01 uF
Capacitance Tolerance	5%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BP
Dissipation Factor	0.15% 1 MHz 25C
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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